

STGW45HF60WDI

45 A, 600 V ultra fast IGBT

Preliminary data

Features

- Improved E_{off} at elevated temperature
- Low C_{RES} / C_{IES} ratio (no cross-conduction susceptibility)
- Low V_F soft recovery antiparallel diode

Applications

- Welding
- Induction heating
- Resonant converters



The "HF" series is based on a new planar technology concept to yield an IGBT with tighter variation of switching energy (E_{off}) versus temperature. Suffix "W" denotes a subset of products tailored to high switching frequency operation over 100 kHz.

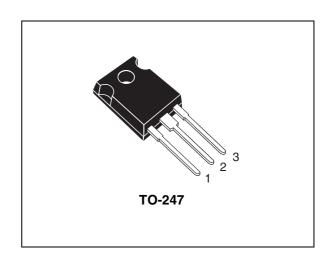


Figure 1. Internal schematic diagram

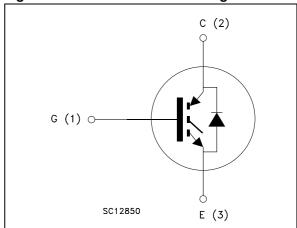


Table 1. Device summary

Order code	der code Marking Package		Packaging
STGW45HF60WDI	GW45HF60WDI	TO-247	Tube
STGWA45HF60WDI	45HF60WDI	TO-247 long leads	Tube

Electrical ratings STGW45HF60WDI

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter		Value	Unit
Symbol	Farameter	TO-247	TO-247 long leads	Unit
V _{CES}	Collector-emitter voltage (V _{GE} = 0)		600	V
I _C ⁽¹⁾	Continuous collector current at T _C = 25 °C	70	80	Α
I _C ⁽¹⁾	Continuous collector current at T _C = 100 °C	45	50	Α
I _{CL} ⁽²⁾	Turn-off latching current	TBD		Α
I _{CP} ⁽³⁾	Pulsed collector current		Α	
V _{GE}	Gate-emitter voltage	± 20		V
I _F	Diode RMS forward current at T _C = 25 °C	30		Α
I _{FSM}	Surge not repetitive forward current t _p = 10 ms sinusoidal	130		Α
P _{TOT}	Total dissipation at T _C = 25 °C	250 310		W
T _{stg}	Storage temperature	– 55 to 150		°C
T _j	Operating junction temperature	1		

^{1.} Calculated according to the iterative formula:

$$I_{C}(T_{C}) = \frac{T_{j(max)} - T_{C}}{R_{thj-c} \times V_{CE(sat)(max)}(T_{j(max)}, I_{C}(T_{C}))}$$

- 2. Pulse width limited by maximum junction temperature and turn-off within RBSOA
- 3. V_{CLAMP} = 80% (V_{CES}), V_{GE} = 15 V, R_{G} = 10 Ω , T_{J} = 150 °C

Table 3. Thermal data

Symbol	Parameter		Unit	
Symbol	Farameter	TO-247	TO-247 long leads	Oiiit
D	Thermal resistance junction-case IGBT	0.5	0.4	°C/W
R _{thj-case}	Thermal resistance junction-case diode		1.5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	50		°C/W

2 Electrical characteristics

 $(T_J = 25 \, ^{\circ}C \text{ unless otherwise specified})$

Table 4. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)CES}	Collector-emitter breakdown voltage (V _{GE} = 0)	I _C = 1 mA	600			V
V _{CE(sat)}	Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_{C} = 30 \text{ A}$ $V_{GE} = 15 \text{V}, I_{C} = 30 \text{ A}, T_{J} = 125 ^{\circ}\text{C}$		1.9 TBD	2.5	V V
V _{GE(th)}	Gate threshold voltage	$V_{CE} = V_{GE}$, $I_C = 1 \text{ mA}$	3.75		5.75	٧
I _{CES}	Collector cut-off current (V _{GE} = 0)	V _{CE} = 600 V V _{CE} = 600 V, T _J = 125 °C			500 5	μA mA
I _{GES}	Gate-emitter leakage current (V _{CE} = 0)	V _{GE} = ±20 V			± 100	nA
9 _{fs}	Forward transconductance	V _{CE} = 15 V _, I _C = 30 A		TBD		S

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{ies} C _{oes} C _{res}	Input capacitance Output capacitance Reverse transfer capacitance	V _{CE} = 25 V, f = 1 MHz, V _{GE} = 0	-	TBD TBD TBD	-	pF pF pF
Q _g Q _{ge} Q _{gc}	Total gate charge Gate-emitter charge Gate-collector charge	$V_{CE} = 390 \text{ V}, I_{C} = 30 \text{ A},$ $V_{GE} = 15 \text{ V},$ Figure 3	-	TBD TBD TBD	-	nC nC nC

Electrical characteristics STGW45HF60WDI

Table 6. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	V_{CC} = 390 V, I_{C} = 30 A R_{G} = 4.7 Ω V_{GE} = 15 V, Figure 2	-	TBD TBD TBD	-	ns ns A/µs
t _{d(on)} t _r (di/dt) _{on}	Turn-on delay time Current rise time Turn-on current slope	$V_{CC} = 390 \text{ V}, I_{C} = 30 \text{ A}$ $R_{G} = 4.7 \Omega, V_{GE} = 15 \text{ V},$ $T_{J} = 125 \text{ °C } \textit{Figure 2}$	-	TBD TBD TBD	-	ns ns A/µs
$t_r(V_{off})$ $t_d(_{off})$ t_f	Off voltage rise time Turn-off delay time Current fall time	$V_{CC} = 390 \text{ V, } I_{C} = 30 \text{ A,}$ $R_{GE} = 4.7 \Omega \text{ V}_{GE} = 15 \text{ V}$ Figure 2	-	TBD TBD TBD	-	ns ns ns
t _r (V _{off}) t _d (_{off}) t _f	Off voltage rise time Turn-off delay time Current fall time	V_{CC} = 390 V, I_{C} = 30 A, R_{GE} = 4.7 Ω V_{GE} =15 V, T_{J} = 125 °C Figure 2	-	TBD TBD TBD	-	ns ns ns

Table 7. Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
E _{off}	Turn-off switching losses	V_{CC} = 390 V, I_{C} = 30 A R_{G} = 4.7 Ω V_{GE} = 15 V, Figure 4	-	330		μJ
E _{off}	Turn-off switching losses	$V_{CC} = 390 \text{ V}, I_{C} = 30 \text{ A}$ $R_{G} = 4.7 \Omega, V_{GE} = 15 \text{ V},$ $T_{J} = 125 \text{ °C}, Figure 4$	-	550	800	μJ

Table 8. Collector-emitter diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V_{F}	Forward on-voltage	I _F = 30 A I _F = 30 A, T _J = 125 °C	-	1.4 1.2	1.8	V V
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_F = 30 \text{ A}, V_R = 50 \text{ V},$ di/dt = 100 A/ μ s Figure 5	-	TBD TBD TBD	-	ns nC A
t _{rr} Q _{rr} I _{rrm}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_F = 30 A,V _R = 50 V, T_J =125 °C, di/dt = 100 A/ μ s Figure 5	-	TBD TBD TBD	-	ns nC A

STGW45HF60WDI Test circuits

3 Test circuits

Figure 2. Test circuit for inductive load switching

Figure 3. Gate charge test circuit

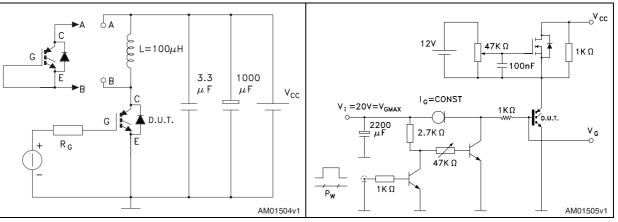
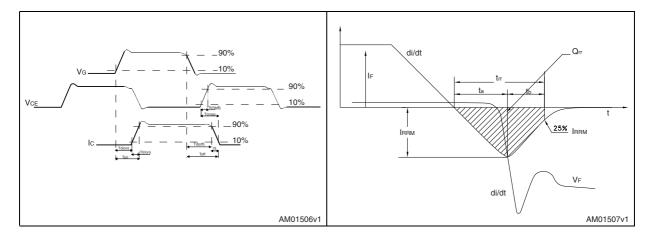


Figure 4. Switching waveform

Figure 5. Diode recovery time waveform



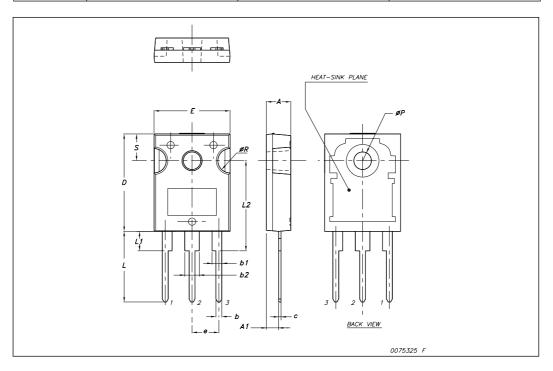
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

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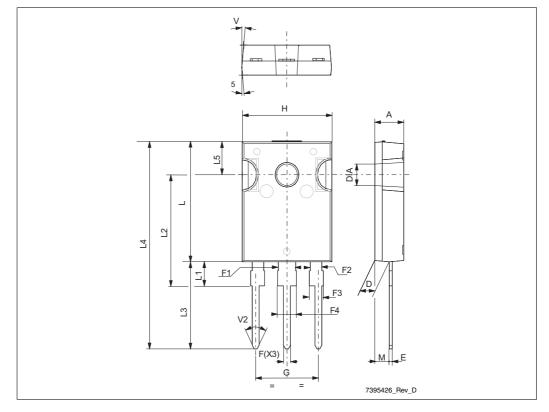
TO-247 Mechanical data

Dim.		mm.			
Dilli.	Min.	Тур	Max.		
Α	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
E	15.45		15.75		
е		5.45			
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
øΡ	3.55		3.65		
øR	4.50		5.50		
S		5.50			



TO-247 I	ong	leads	mechanical	data
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D!	mm			
Dim.	Min.	Тур.	Max.	
Α	4.85		5.16	
D	2.2		2.6	
Е	0.4		0.8	
F	1		1.4	
F1		3		
F2		2		
F3	1.9		2.4	
F4	3		3.4	
G		10.9		
Н	15.45		16.03	
L	19.85		21.09	
L1	3.7		4.3	
L2	18.3		19.13	
L3	14.2		20.3	
L4	34.05		41.38	
L5	5.35		6.3	
М	2		3	
V		5°		
V2		60°		
DIAM	3.55		3.65	



STGW45HF60WDI Revision history

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
04-Aug-2009	1	Initial release.

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